

Trench[™] Power MOSFET

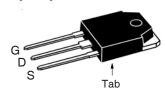
IXTQ130N20T IXTH130N20T

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



$V_{\scriptscriptstyle DSS}$	=	200V
I _{D25}	=	130A
R _{DS(on)}	≤	$16 \mathrm{m}\Omega$

TO-3P (IXTQ)



Test Conditions	Maximum Ratings		
T _{_i} = 25°C to 175°C	200	V	
$T_J = 25^{\circ}\text{C to } 175^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	200	V	
Continuous	± 20	V	
Transient	± 30	V	
T _C = 25°C	130	A	
Lead Current Limit, RMS	75	Α	
$T_{\rm c} = 25$ °C, Pulse Width Limited by $T_{\rm JM}$	320	Α	
T _C = 25°C	4	Α	
$T_{C} = 25^{\circ}C$	1	J	
$I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 175^{\circ}\mathrm{C}$	10	V/ns	
T _C = 25°C	830	W	
	-55 +175	°C	
	175	°C	
	-55 +175	°C	
Maximum Lead Temperature for Soldering	300	°C	
1.6 mm (0.062in.) from Case for 10s	260	°C	
Mounting Torque	1.13 / 10	Nm/lb.in	
TO-3P TO-247	5.5 6.0		
	$T_{_{J}}=25^{\circ}\text{C to }175^{\circ}\text{C}$ $T_{_{J}}=25^{\circ}\text{C to }175^{\circ}\text{C}, R_{_{GS}}=1\text{M}\Omega$ Continuous Transient $T_{_{C}}=25^{\circ}\text{C}$ Lead Current Limit, RMS $T_{_{C}}=25^{\circ}\text{C}, \text{ Pulse Width Limited by }T_{_{JM}}$ $T_{_{C}}=25^{\circ}\text{C}$ $T_{_{C}}=25^{\circ}\text{C}$ $I_{_{S}}\leq I_{_{DM}}, V_{_{DD}}\leq V_{_{DSS}}, T_{_{J}}\leq 175^{\circ}\text{C}$ $T_{_{C}}=25^{\circ}\text{C}$ $T_{_{C}}=25^{\circ}\text{C}$ Maximum Lead Temperature for Soldering 1.6 mm (0.062in.) from Case for 10s Mounting Torque $T\text{O-3P}$	$ T_{_{J}} = 25^{\circ}\text{C to } 175^{\circ}\text{C} \\ T_{_{J}} = 25^{\circ}\text{C to } 175^{\circ}\text{C}, \ R_{_{GS}} = 1\text{M}\Omega $ 200	

TO-247 (IXTH)	•
G //	
DS	Tab

G = Gate D = Drain S = Source Tab = Drain

Features

- High Current Handling Capability
- Avalanche Rated
- Fast Intrinsic rectifier
- Low R_{DS(on)}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- High Speed Power Switching Applications

Symbol (T _J = 25°C	Test Conditions Unless Otherwise Specified)	Char Min.	acterist Typ.	ic Valu Max.	
BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	200			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 1mA$	2.5		5.0	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 150^{\circ}C$			25 500	μA μA
R _{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1			16	mΩ



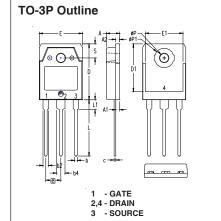
Symbol	Test Conditions	Cha	racteristic	Values
$(T_J = 25^{\circ}C U)$	Inless Otherwise Specified)	Min.	Тур.	Max.
g _{fs}	$V_{DS} = 10V$, $I_{D} = 60A$, Note 1	70	120	S
C _{iss}			8800	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		970	pF
C _{rss}			122	pF
t _{d(on)}	Resistive Switching Times		25	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		18	ns
t _{d(off)}	30 30 300 3		57	ns
t,	$R_{\rm G} = 2\Omega$ (External)		22	ns
Q _{g(on)}			150	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 25A$		44	nC
Q_{gd}			42	nC
R _{thJC} R _{thCS}			0.25	0.18 °C/W °C/W

Source-Drain Diode

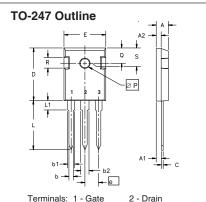
			racteristic Values		
$(T_J = 25^{\circ}C U)$	nless Otherwise Specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			130	A
SM	Repetitive, Pulse Width Limited by $\rm T_{_{\rm JM}}$			520	Α
V _{SD}	$I_{\scriptscriptstyle F} = 50A, \ V_{\scriptscriptstyle GS} = 0V, \ \text{Note 1}$			1.0	V
t _{rr}	$I_F = 65A$, -di/dt = 100A/ μ s		150		ns
	$V_{R} = 100V, V_{GS} = 0V$				

1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$. Note

IXTH130N20T



SYM	INCH	IES .	MILLIME	
2110	MIN	MAX	MIN	MAX
Α	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
Ь	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
С	.022	.031	0.55	0.80
D	.780	.799	19.80	20.30
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
е	.215	215 BSC 5.45 BSC		BSC
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
ØΡ	.126	.134	3.20	3.40
øP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10



Terminals: 1 - Gate 3 - Source

Dim.	Millimeter		Inc	hes
	Min.	Max.	Min.	Max.
Α	4.7	5.3	.185	.209
A,	2.2	2.54	.087	.102
A ₂	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b₁	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
С	.4	.8	.016	.031
D	20.80	21.46	.819	.845
Е	15.75	16.26	.610	.640
е	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

Fig. 1. Output Characteristics @ T_J = 25°C

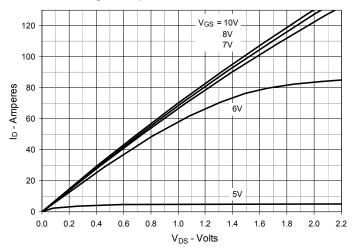


Fig. 2. Extended Output Characteristics @ T_J = 25°C

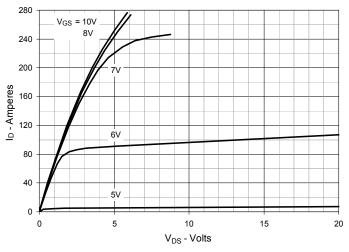


Fig. 3. Output Characteristics @ T_J = 150°C

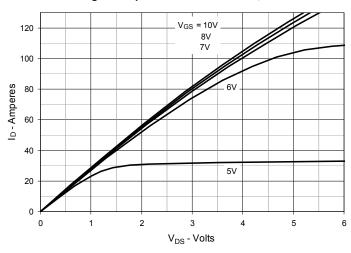


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 65A Value vs. Junction Temperature

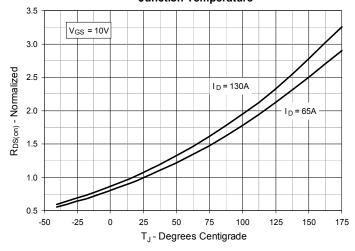


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 65A Value vs.

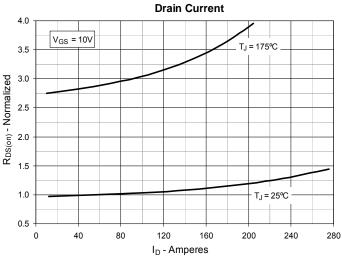
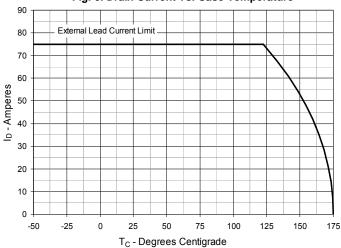
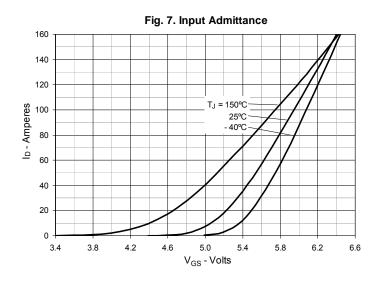
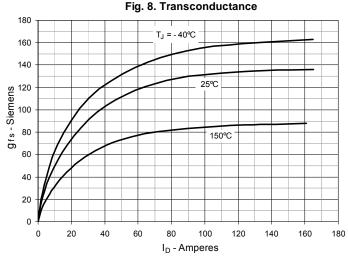


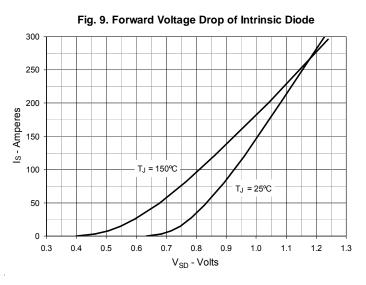
Fig. 6. Drain Current vs. Case Temperature

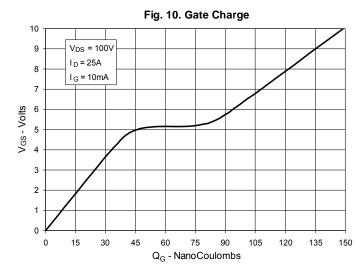


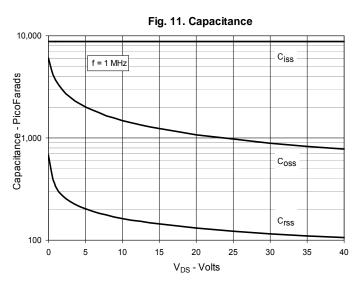


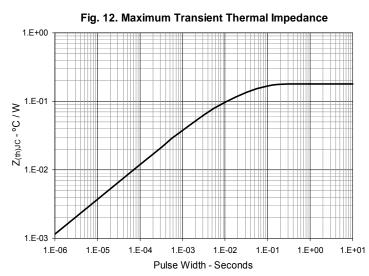












 $\ensuremath{\mathsf{IXYS}}$ Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs.

Drain Current T_J = 25℃ tr-Nanoseconds $R_G = 2\Omega$, $V_{GS} = 15V$ $V_{DS} = 100V$ T_J = 125℃ I_D - Amperes

Fig. 14. Resistive Turn-on Rise Time vs.

Fig. 15. Resistive Turn-on Switching Times vs.
Gate Resistance

T_{.I} - Degrees Centigrade

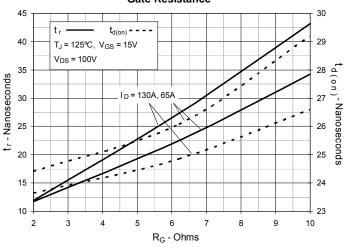


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

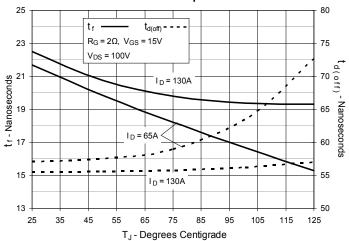


Fig. 17. Resistive Turn-off Switching Times vs.

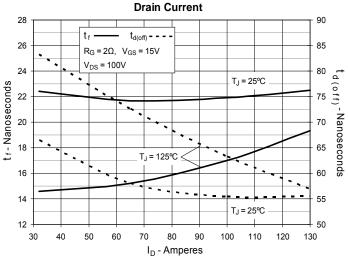


Fig. 18. Resistive Turn-off Switching Times vs.

Gate Resistance

